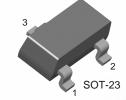


## KST92/93

**High Voltage Transistor** 



## PNP Epitaxial Silicon Transistor

1. Base 2. Emitter 3. Collector

### **Absolute Maximum Ratings** T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector Base Voltage	an Marian P	
	: KST92	-300	V
	: KST93	-200	V
$V_{CEO}$	Collector-Emitter Voltage		
	: KST92	-300	V
	: KST93	-200	V
V <sub>EBO</sub>	Emitter-Base Voltage	-5	V
I <sub>C</sub>	Collector Current	-500	mA
P <sub>C</sub>	Collector Power Dissipation	350	mW
T <sub>STG</sub>	Storage Temperature	150	°C
R <sub>TH</sub> (j-a)	Thermal Resistance junction to Ambient	357	°C/W

Refer to KSP92/93 for graphs

### Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

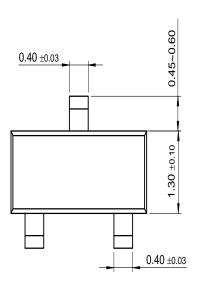
Symbol	Parameter	Test Condition	Min.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> = -100μA, I <sub>E</sub> =0			
	: KST92		-300		V
	: KST93		-200		V
BV <sub>CEO</sub>	* Collector-Emitter Breakdown Voltage	I <sub>C</sub> = -1mA, I <sub>B</sub> =0			
	: KST92		-300		V
	: KST93		-200		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> = -100μA, I <sub>C</sub> =0	-5		V
I <sub>CBO</sub>	Collector Cut-off Current			4 07	
	: KST92	$V_{CB} = -200V, I_{E} = 0$	WW	-0.25	μΑ
	: KST93	$V_{CB} = -160V, I_{E} = 0$		-0.25	μA
I <sub>EBO</sub>	Emitter Cut-off Current	V <sub>EB</sub> = -5V, I <sub>C</sub> =0		-0.1	μΑ
h <sub>FE</sub>	* DC Current Gain	$V_{CF} = -10V, I_{C} = -1mA$	25		
	THE COM	$V_{CE} = -10V, I_{C} = -10mA$	40		
	OZSU.	$V_{CE} = -10V, I_{C} = -30mA$	25		
V <sub>CE</sub> (sat)	* Collector-Emitter Saturation Voltage	I <sub>C</sub> = -20mA, I <sub>B</sub> = -2mA		-0.5	V
V <sub>BE</sub> (sat)	* Base-Emitter Saturation Voltage	I <sub>C</sub> = -20mA, I <sub>B</sub> = -2mA		-0.9	V
Cob	Output Capacitance				
	: KST92	$V_{CB} = -20V, I_{E} = 0$		6	pF
	: KST93	f=1MHz		8	pF
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = -20V, I <sub>C</sub> = -10mA	50		MHz
		f=100MHz			

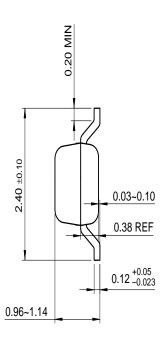
range Test: PW≤300μs, Duty Cycle≤2%

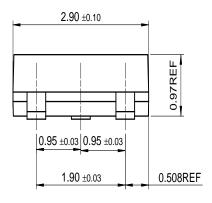
Type KST92 Mark 2D  Marking  2D	KST93 2E
Marking	
_=	
_=	
2D	

# **Package Dimensions**

# SOT-23







Dimensions in Millimeters

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E <sup>2</sup> CMOS <sup>TM</sup>	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	I <sup>2</sup> C <sup>TM</sup>	$OCX^{TM}$	RapidConfigure™	UHC™ _
Across the board.	. Around the world.™	OCXPro™	RapidConnect™	UltraFET <sup>®</sup>
The Power Franchise™		OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX™
Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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